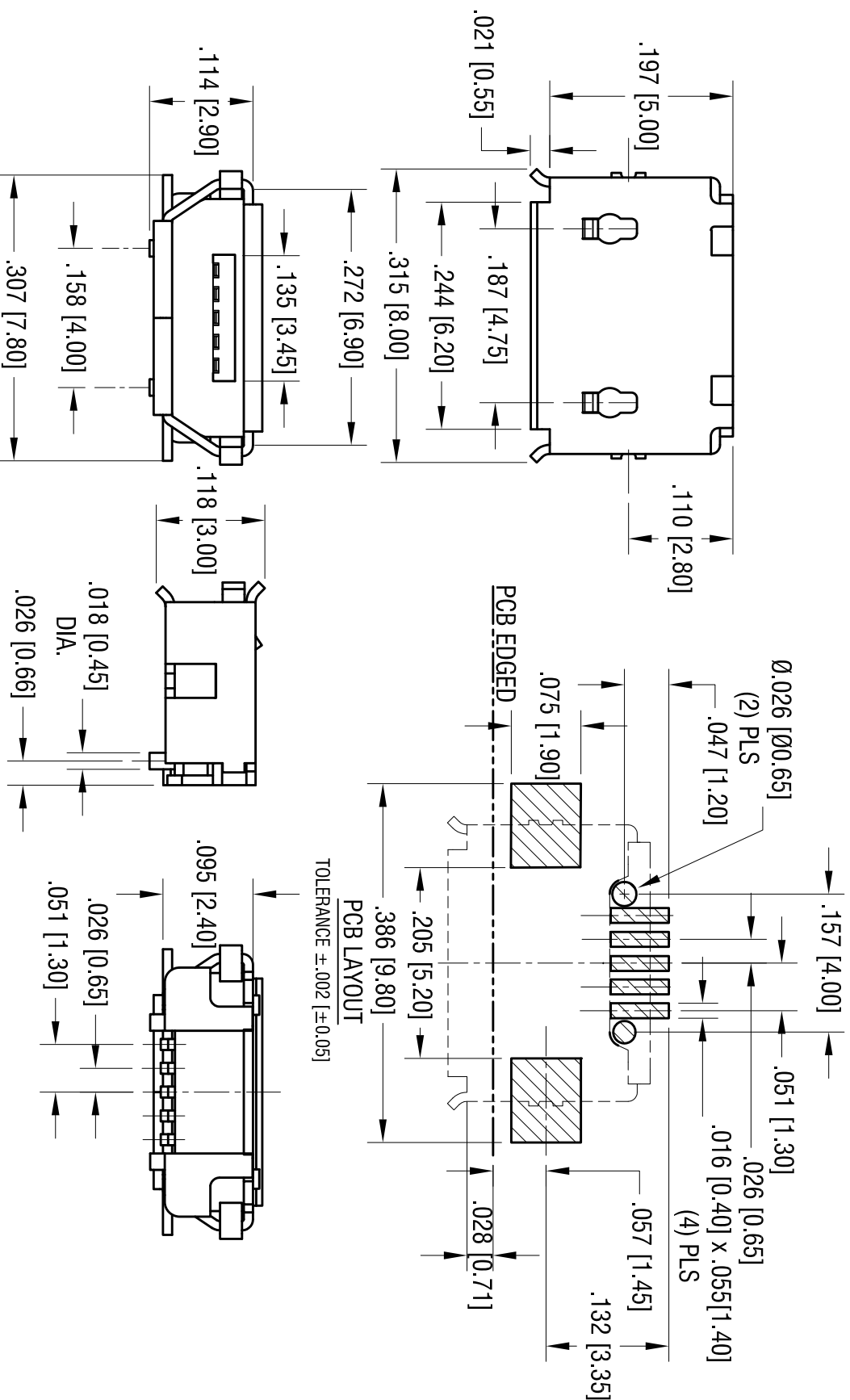


DATE	DESCRIPTION	REV.
5.31.11	CHANGE AS PER ECN 11-074	A
9.08.21	CHANGE AS PER ECN 21-103 SHELL PLATING WAS NICKEL	B



TOLERANCE ±.002 [±0.05]

**Notes:**

**Material:**

Shell: Brass, Matte Tin Plate.  
Insulator: Thermoplastic, UL 94-0 LCP  
Contacts: Phosphor Bronze

**Finish:**

Contact Area: Gold Plate over Nickel Plate  
on Solder Tail: Tin Plate over Nickel Plate  
Electrical Specifications  
Rated Voltage: 30V DC  
Contact Resistance: 50 milliohms Max.  
Dielectric Withstanding: 300V AC AT  
Mate force: 3.0 kgf max.  
Umate force: 0.7 kgf min.

**KEYSTONE ELECTRONICS CORP.**

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PART NAME

MICRO USB SMT PLUG

MATERIAL

AS NOTED

FINISH

AS NOTED

**ACTUAL SIZE**



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TOLERANCES	INCH	[MM]	CODE	DWG. NO.
DECIMAL	± .005	[± 0.13 ]	C	940
ANGULAR	± 1°			

DRN BY	DATE
NT	11.18.09

APP'D	SCALE
LN	6X